



A Product Line of Diodes Incorporated



3MHz, 1A STEP-DOWN DC-DC CONVERTER

Description

The PAM2304 is a step-down current-mode, DC-DC converter. At heavy load, the constant frequency PWM control performs excellent stability and transient response. To ensure the longest battery life in portable applications, the PAM2304 provides a power-saving Pulse-Skipping Modulation (PSM) mode to reduce quiescent current under light load operation to save power.

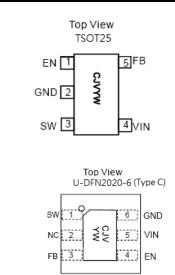
The PAM2304 supports a range of input voltages from 2.5V to 5.5V, allowing the use of a single Li+/Li-polymer cell, multiple Alkaline/NiMH cell, USB and other standard power sources. The output voltage is adjustable from 0.6V to the input voltage. All versions employ internal power switch and synchronous rectifier to minimize external part count and realize high efficiency. During shutdown, the input is disconnected from the output and the shutdown current is less than 1 μ A. Other key features include under-voltage lockout to prevent deep battery discharge.

The PAM2304 is available in TSOT25 and U-DFN2020-6 packages.

Features

- Efficiency up to 95%
- Only 40µA (typ) Quiescent Current
- Output Current: Up to 1A
- Internal Synchronous Rectifier
- 3MHz Switching Frequency
- Soft Start
- Under-Voltage Lockout
- Short Circuit Protection
- Thermal Shutdown
- Small TSOT25 and U-DFN2020-6 Packages
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

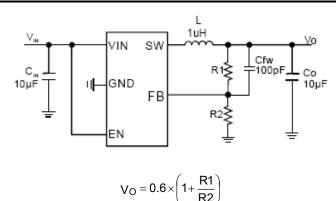
Pin Assignments



Applications

- Smart Phone
- MID
- Portable Electronics
- Wireless Devices
- Cordless Phone
- Computer Peripherals
- Battery Powered Widgets
- Electronic Scales
- Digital Frame
- Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
 - 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
 - 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

Typical Applications Circuit



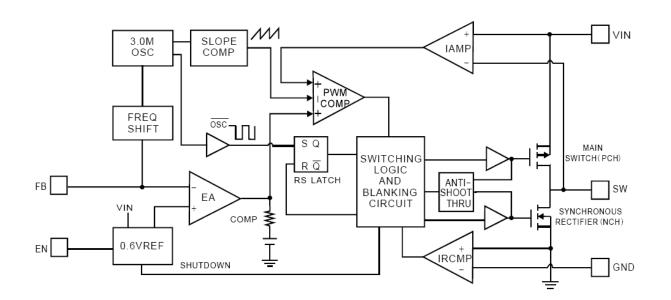




Pin Descriptions

Pin	Function			
Name	TSOT25 U-DFN2020-6			
EN	1	4	Enable Control Input. Force this pin voltage above 1.5V, enables the chip, and below 0.3V shuts down the device.	
GND	2	6	Ground.	
SW	3	1	The drains of the internalmain and synchronous power MOSFET.	
VIN	4	5	Chip main power supply pin.	
FB	5	3	Feedback voltage to internal error amplifier, the threshold voltage is 0.6V.	
AGND	—	— Analog Ground.		
PGND	_	—	— Main power ground return pin.	
NC	- 2 Not connected.			

Functional Block Diagram



Absolute Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

These are stress ratings only and functional operation is not implied. Exposure to absolute maximum ratings for prolonged time periods may affect device reliability. All voltages are with respect to ground.

Parameter	Rating	Unit
Input Voltage	-0.3 to +6.0	V
EN, FB Pin Voltage	-0.3 to V _{IN}	V
SW Pin Voltage	-0.3 to (V _{IN} +0.3)	V
Junction Temperature	150	°C
Storage Temperature Range	-65 to +150	°C
Soldering Temperature	300, 5 sec	°C





Recommended Operating Conditions (@T_A = +25°C, unless otherwise specified.)

Parameter	Rating	Unit
Supply Voltage	2.7 to 5.5	V
Operation Temperature Range	-40 to +85	°C
Junction Temperature Range	-40 to +125	U U

Thermal Information

Parameter	Symbol	Package	Мах	Unit
Thermal Resistance (Junction to Case)	0	TSOT25 (Note 4)	130	
Thermal Resistance (Junction to Case)	θ _{JC}	U-DFN2020-6	25	°C/W
Thermal Resistance (Junction to Ambient)	θ _{JA}	TSOT25	250	C/VV
Thermal Resistance (Junction to Ambient)		U-DFN2020-6	68	
Internal Down Dissignation (T 195°C)	P	TSOT25	400	m\//
Internal Power Dissipation ($T_A = +25^{\circ}C$)	PD	U-DFN2020-6	980	mW

Note: 4. The maximun output current for TSOT25 package is limited by internal power dissipation capacity as described in Application Information hereinafter.

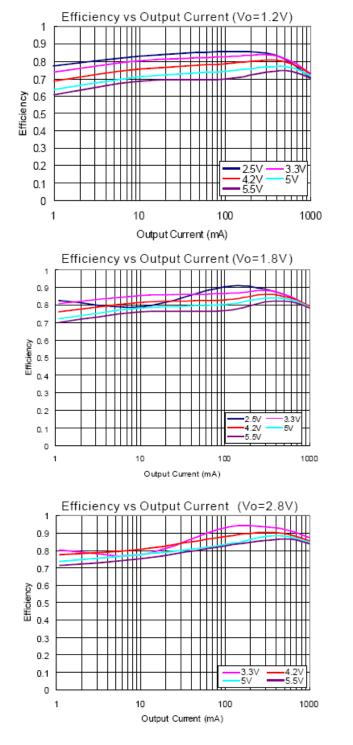
Electrical Characteristics (@T_A = +25°C, V_{IN} = 3.6V, V_O = 1.8V, C_{IN} = 10 μ F, C_{OUT} = 10 μ F, L = 1 μ H, unless otherwise specified.)

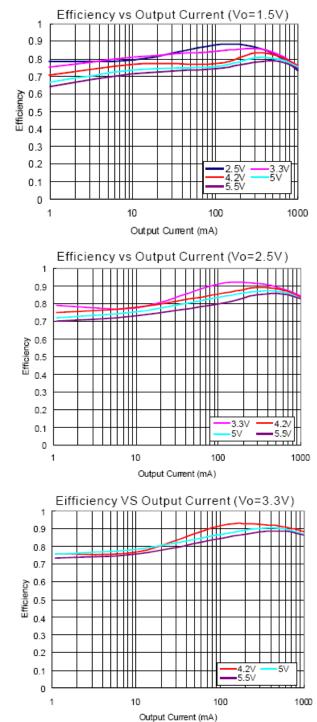
Parameter	Symbol	Test C	onditions	Min	Тур	Max	Units
Input Voltage Range	VIN			2.5		5.5	V
Regulated Feedback Voltage	V _{FB}			0.588	0.6	0.612	V
Reference Voltage Line Regulation	ΔV_{FB}				0.3		%/V
Regulated Output Voltage Accuracy	Vo	I _O = 100mA		-3		+3	%
Peak Inductor Current	I _{PK}	V _{IN} = 3V, V _{FB} = 0.5V	/ or V _O = 90%		1.5		А
Output Voltage Line Regulation	LNR	V_{IN} = 2.5V to 5V, I _C) = 10mA		0.2	0.5	%/V
Output Voltage Load Regulation	LDR	I_{O} = 1mA to 800mA			0.5	1.5	%
Quiescent Current	lq	No load			40	70	μA
Shutdown Current	I _{SD}	V _{EN} = 0V				1	μA
		V _O = 100%			3		MHz
Oscillator Frequency	fosc	$V_{FB} = 0V \text{ or } V_O = 0V$			1		MHz
Drain-Source On-State Resistance	Proven	I _{DS} = 100mA	P MOSFET		0.30	0.45	Ω
	R _{DS(ON)}		N MOSFET		0.35	0.50	Ω
SW Leakage Current	SW Leakage Current I _{LSW}				±0.01	1	μA
High Efficiency	η				95		%
EN Threshold High	V _{EH}			1.5			V
EN Threshold Low	V _{EL}					0.3	V
EN Leakage Current	I _{EN}				±0.01		μA
Over Temperature Protection	OTP				150		°C
OTP Hysteresis	OTH				30		°C





Typical Performance Characteristics (@T_A = +25°C, C_{IN} = 10µF, C_{OUT} = 10µF, L = 1µH, unless otherwise specified.)







1mA

0.1A

0.6A

4.5

1mA

0.1A

0.6 A

1mA

0 14

0.6A

5

4.5

10mA

0.3A

5.5

1A

4.5

4

10mA

5.5

0.3A

1A

10mA

0.3A

5.5

1A

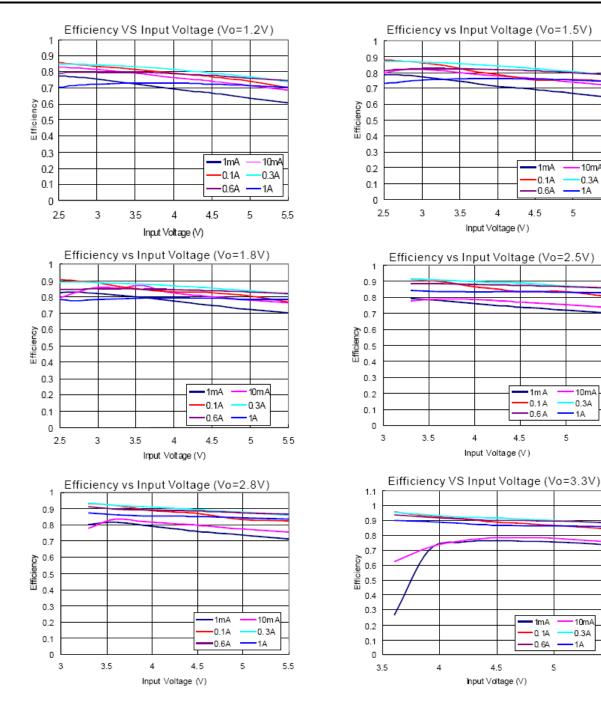
5

5



Typical Performance Characteristics (cont.)

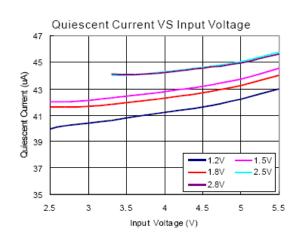
 $(\textcircled{O}T_A = +25^{\circ}C, C_{IN} = 10\mu$ F, $C_{OUT} = 10\mu$ F, L = 1 μ H, unless otherwise specified.)

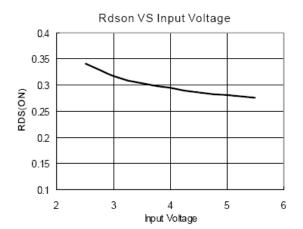


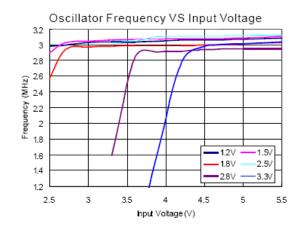


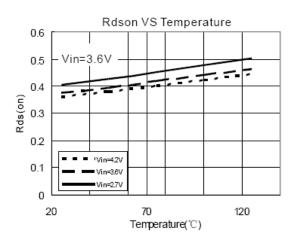


$\label{eq:tau} \begin{array}{l} \textbf{Typical Performance Characteristics} (cont.) \\ (@T_A = +25^{\circ}C, \ C_{IN} = 10 \mu\text{F}, \ C_{OUT} = 10 \mu\text{F}, \ L = 1 \mu\text{H}, \ unless \ otherwise \ specified.) \end{array}$













Application Information

The basic PAM2304 application circuit is shown on Page 2. External component selection is determined by the load requirement, selecting L first and then C_{IN} and C_{OUT}.

Inductor Selection

For most applications, the value of the inductor will fall in the range of 1µH. Its value is chosen based on the desired ripple current. Large value inductors lower ripple current and small value inductors result in higher ripple currents. Higher V_{IN} or V_{OUT} also increases the ripple current as shown in Equation 1. A reasonable starting point for setting ripple current is $\Delta I_L = 400$ mA (40% of 1A).

$$\Delta I_{L} = \frac{1}{(f)(L)} V_{OUT} \left(1 - \frac{V_{OUT}}{V_{IN}} \right)$$
 Equation (1)

The DC current rating of the inductor should be at least equal to the maximum load current plus half the ripple current to prevent core saturation. Thus, a 1.4A rated inductor should be enough for most applications (1A + 400mA). For better efficiency, choose a low DC-resistance inductor.

CIN and COUT Selection

In continuous mode, the source current of the top MOSFET is a square wave of duty cycle V_{OUT}/V_{IN}. To prevent large voltage transients, a low ESR input capacitor sized for the maximum RMS current must be used. The maximum RMS capacitor current is given by:

$$C_{\text{IN}} \text{required}_{\text{IRMS}} \cong I_{\text{OMAX}} \frac{\left[V_{\text{OUT}} \left(V_{\text{IN}} - V_{\text{OUT}}\right)\right]^{1/2}}{V_{\text{IN}}}$$

This formula has a maximum at V = $2V_{OUT}$, where $I_{RMS} = I_{OUT}/2$. This simple worst-case condition is commonly used for design because even significant deviations do not offer much relief. Note that the capacitor manufacturer's ripple current ratings are often based on 2000 hours of life. This makes it advisable to further derate the capacitor, or choose a capacitor rated at a higher temperature than required. Consult the manufacturer if there is any question. The selection of C_{OUT} is driven by the required effective series resistance (ESR).

Typically, once the ESR requirement for C_{OUT} has been met, the RMS current rating generally far exceeds the $I_{RIPPLE}(P-P)$ requirement. The output ripple ΔV_{OUT} is determined by:

$$\Delta V_{OUT} \cong \Delta I_L \left(ESR + \frac{1}{8fC_{OUT}} \right)$$

Where f = operating frequency, C_{OUT} = output capacitance and ΔI_L = ripple current in the inductor. For a fixed output voltage, the output ripple is highest at maximum input voltage since ΔI_L increases with input voltage.

Using Ceramic Input and Output Capacitors

Higher values, lower cost ceramic capacitors are now becoming available in smaller case sizes. Their high ripple current, high voltage rating and low ESR make them ideal for switching regulator applications. Using ceramic capacitors can achieve very low output ripple and small circuit size.

When choosing the input and output ceramic capacitors, choose the X5R or X7R dielectric formulations. These dielectrics have the best temperature and voltage characteristics of all the ceramics for a given value and size.

Thermal Consideration

Thermal protection limits power dissipation in the PAM2304. When the junction temperature exceeds +150°C, the OTP (Over Temperature Protection) starts the thermal shutdown and turns the pass transistor off. The pass transistor resumes operation after the junction temperature drops below +120°C.

For continuous operation, the junction temperature should be maintained below +125°C. The power dissipation is defined as:

$$P_{D} = I_{O}^{2} \frac{V_{O \ DS(ON)H} + (V_{IN} - V_{O})R_{DS(ON)L}}{V_{IN}} + (t_{SW} F_{S} I_{O} + I_{Q})V_{IN}$$

I_Q is the step-down converter quiescent current. The term tsw is used to estimate the full load step-down converter switching losses.





Application Information (cont.)

Thermal Consideration (cont.)

For the condition where the step-down converter is in dropout at 100% duty cycle, the total device dissipation reduces to:

 $P_D = I_O{}^2 R_{DS(ON)H} + I_Q V_{IN}$

Since $R_{DS(ON)}$, quiescent current and switching losses all vary with input voltage, the total losses should be investigated over the complete input voltage range. The maximum power dissipation depends on the thermal resistance of IC package, PCB layout, the rate of surrounding airflow and temperature difference between junction and ambient. The maximum power dissipation can be calculated by the following formula:

$$P_D = \frac{T_{J(MAX)} - T_A}{\theta_{JA}}$$

Where TJ(max) is the maximum allowable junction temperature +125°C. T_A is the ambient temperature and θ_{JA} is the thermal resistance from the junction to the ambient. Based on the standard JEDEC for a two layers thermal test board, the thermal resistance of TSOT25 package is 250°C/W. The maximum power dissipation at T_A = +25°C can be calculated by following formula:

 $P_D = (125^{\circ}C-25^{\circ}C)/250^{\circ}C/W = 0.4W$

Setting the Output Voltage

The internal reference is 0.6V (Typical). The output voltage is calculated as below:

$$V_{O} = 0.6 \times \left(1 + \frac{R1}{R2}\right)$$

The output voltage is given by Table 1.

Vo	R1	R2
1.2V	100k	100k
1.5V	150k	100k
1.8V	200k	100k
2.5V	380k	120k
3.3V	540k	120k

100% Duty Cycle Operation

As the input voltage approaches the output voltage, the converter turns the P-Channel transistor continuously on. In this mode the output voltage is equal to the input voltage minus the voltage drop across the P-Channel transistor:

 $V_{OUT} = V_{IN} - I_{LOAD} (R_{DS(ON)} + R_L)$

where R_{DS(ON)} = P-Channel Switch ON Resistance, I_{LOAD} = Output Current, R = Inductor DC Resistance

UVLO and Soft-Start

The reference and the circuit remain reset until the V_{IN} crosses its UVLO threshold.

The PAM2304 has an internal soft-start circuit that limits the in-rush current during start-up. This prevents possible voltage drops of the input voltage and eliminates the output voltage overshoot. The soft-start acts as a digital circuit to increase the switch current in several steps to the P-Channel current limit (1500mA).

Short Circuit Protection

The switch peak current is limited cycle-by-cycle to a typical value of 1500mA. In the event of an output voltage short circuit, the device operates with a frequency of 1MHz and minimum duty cycle, therefore the average input current is typically 200mA.

Thermal Shoutdown

When the die temperature exceeds +150°C, a reset occurs and the reset remains until the temperature decrease to +120°C, at which time the circuit can be restarted.



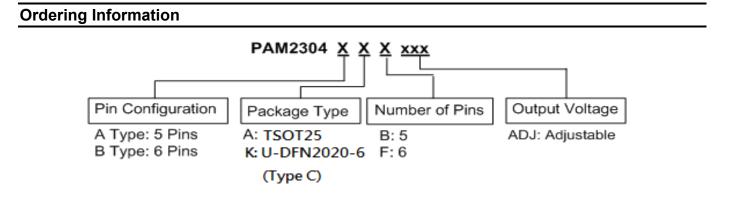


Application Information (cont.)

PCB Layout Check List

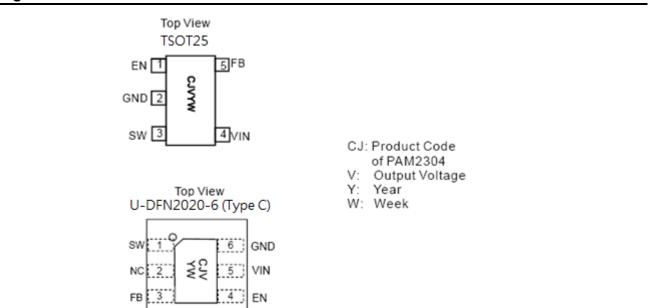
When laying out the printed circuit board, the following checklist should be used to ensure proper operation of the PAM2304. These items are also illustrated graphically in Figure 1. Check the following in your layout:

- 1. The power traces, consisting of the GND trace, the SW trace and the VIN trace should be kept short, direct and wide.
- 2. Does the V_{FB} pin connect directly to the feedback resistors? The resistive divider R1/R2 must be connected between the (+) plate of C_{OUT} and ground.
- 3. Does the (+) plate of C_{IN} connect to V_{IN} as closely as possible? This capacitor provides the AC current to the internal power MOSFETs.
- 4. Keep the switching node, SW, away from the sensitive V_{FB} node.
- 5. Keep the (–) plates of C_{IN} and C_{OUT} as close as possible.



Part Number	Output Voltage	Package	Packaging
PAM2304AABADJ	ADJ	TSOT25	3000 Units/Tape & Reel
PAM2304BKFADJ	ADJ	U-DFN2020-6 (Type C)	3000 Units/Tape & Reel

Marking Information



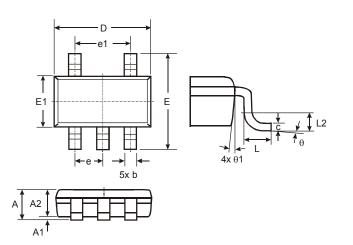




Package Outline Dimensions (All dimensions in mm.)

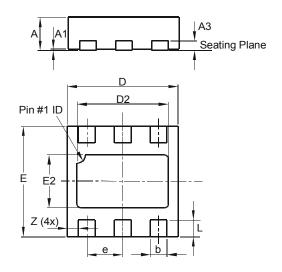
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.

TSOT25



TSOT25					
Dim	Dim Min Max Typ				
Α	-	1.00	-		
A1	0.01	0.10	-		
A2	0.84	0.90	-		
D	-	-	2.90		
ш	-	-	2.80		
E1	-	-	1.60		
b	0.30	0.45	-		
С	0.12	0.20	-		
e	-	-	0.95		
e1	-	-	1.90		
L	0.30	0.50			
L2	_	_	0.25		
θ	0°	8°	4°		
θ1	4°	12°	_		
All D	All Dimensions in mm				

U-DFN2020-6



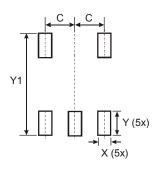
U-DFN2020-6						
	Type C					
Dim	Min	Max	Тур			
Α	0.57	0.63	0.60			
A1	0.00	0.05	0.02			
A3			0.15			
b	0.25	0.35	0.30			
D	1.95	2.075	2.00			
D2	1.55	1.75	1.65			
Е	1.95	2.075	2.00			
E2	0.86	1.06	0.96			
е			0.65			
L	0.25	0.35	0.30			
Ζ		_	0.20			
All Dimensions in mm						





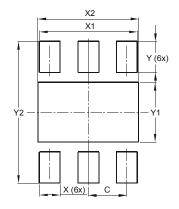
Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version. **TSOT25**



Dimensions	Value (in mm)
С	0.950
Х	0.700
Y	1.000
Y1	3.199

U-DFN2020-6



Dimensions	Value (in mm)
C	0.650
Х	0.350
X1	1.650
X2	1.700
Y	0.525
Y1	1.010
Y2	2.400





IMPORTANT NOTICE

DIODES INCORPORATED MAKES NO WARRANTY OF ANY KIND, EXPRESS OR IMPLIED, WITH REGARDS TO THIS DOCUMENT, INCLUDING, BUT NOT LIMITED TO, THE IMPLIED WARRANTIES OF MERCHANTABILITY AND FITNESS FOR A PARTICULAR PURPOSE (AND THEIR EQUIVALENTS UNDER THE LAWS OF ANY JURISDICTION).

Diodes Incorporated and its subsidiaries reserve the right to make modifications, enhancements, improvements, corrections or other changes without further notice to this document and any product described herein. Diodes Incorporated does not assume any liability arising out of the application or use of this document or any product described herein; neither does Diodes Incorporated convey any license under its patent or trademark rights, nor the rights of others. Any Customer or user of this document or products described herein in such applications shall assume all risks of such use and will agree to hold Diodes Incorporated and all the companies whose products are represented on Diodes Incorporated website, harmless against all damages.

Diodes Incorporated does not warrant or accept any liability whatsoever in respect of any products purchased through unauthorized sales channel. Should Customers purchase or use Diodes Incorporated products for any unintended or unauthorized application, Customers shall indemnify and hold Diodes Incorporated and its representatives harmless against all claims, damages, expenses, and attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized application.

Products described herein may be covered by one or more United States, international or foreign patents pending. Product names and markings noted herein may also be covered by one or more United States, international or foreign trademarks.

This document is written in English but may be translated into multiple languages for reference. Only the English version of this document is the final and determinative format released by Diodes Incorporated.

LIFE SUPPORT

Diodes Incorporated products are specifically not authorized for use as critical components in life support devices or systems without the express written approval of the Chief Executive Officer of Diodes Incorporated. As used herein:

A. Life support devices or systems are devices or systems which:

1. are intended to implant into the body, or

- 2. support or sustain life and whose failure to perform when properly used in accordance with instructions for use provided in the labeling can be reasonably expected to result in significant injury to the user.
- B. A critical component is any component in a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or to affect its safety or effectiveness.

Customers represent that they have all necessary expertise in the safety and regulatory ramifications of their life support devices or systems, and acknowledge and agree that they are solely responsible for all legal, regulatory and safety-related requirements concerning their products and any use of Diodes Incorporated products in such safety-critical, life support devices or systems, notwithstanding any devices- or systems-related information or support that may be provided by Diodes Incorporated. Further, Customers must fully indemnify Diodes Incorporated and its representatives against any damages arising out of the use of Diodes Incorporated products in such safety-critical, life support devices or systems.

Copyright © 2014, Diodes Incorporated

www.diodes.com

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

Diodes Incorporated: <u>PAM2304BKFADJ</u> PAM2304AABADJ